

General Purpose Amplifier

Package Style: S0T8

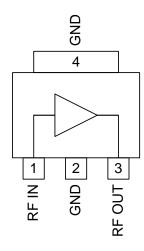


Features

- DC to >6000MHz Operation
- Internally Matched Input and Output
- 22dB Small Signal Gain
- +2.0dB Noise Figure
- +11dBm Output P1dB
- Useable with 5V Supply

Applications

- Basestation Applications
- Broadband, Low-Noise Gain Blocks
- IF or RF Buffer Amplifiers
- Driver Stage for Power Amplifiers
- Final PA for Low-Power Applications
- High Reliability Applications



Functional Block Diagram

Product Description

The RF3376 is a general purpose, low-cost RF amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as an easily-cascadable 50Ω gain block. Applications include IF and RF amplification in wireless voice and data communication products operating in frequency bands up to 6000 MHz. The device is self-contained with 50Ω input and output impedances and requires only two external DC-biasing elements to operate as specified.

Ordering Information

RF3376 Sample bag with 25 pieces RF3376SR 7" reel with 100 pieces RF3376TR13 13" reel with 2500 pieces

RF3376PCK-410 OMHz to 6000MHz PCBA with 5-piece sample bag

RF3376



Absolute Maximum Ratings

Parameter	Rating	Unit
Input RF Power	+3	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-60 to +150	°C
I _{CC}	50	mA



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

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Parameter	Specification		Unit	Condition		
Faraineter	Min.	Тур.	Max.	Ullit	Condition	
Overall					T=25 °C, I _{CC} =35 mA (See Note 1.)	
Frequency Range		DC to >6000		MHz		
3dB Bandwidth		2		GHz		
Gain		23.5		dB	Freq=500MHz	
		22.5		dB	Freq=1000MHz	
	18.0	19.8		dB	Freq=2000MHz	
		18.0		dB	Freq=3000MHz	
		16.0			Freq=4000MHz	
		12.8			Freq=6000MHz	
Noise Figure		2.0		dB	Freq=2000MHz	
Input VSWR		<2:1			In a 50Ω system, DC to 4500MHz	
Output VSWR		<2:1			In a 50Ω system, DC to 6000MHz	
Output IP ₃		+24.4		dBm	Freq=1000MHz	
	+21.5	+23.4		dBm	Freq=2000MHz	
Output P _{1dB}		+11.5		dBm	Freq=1000MHz	
	+9.5	+11.5		dBm	Freq=2000MHz	
Reverse Isolation		22.5		dB	Freq=2000MHz	
Thermal					I _{CC} =35mA (See Note 3.)	
Theta _{JC}		216		°C/W		
Maximum Measured Junction Temperature at DC Bias Conditions		110		°C	T _{CASE} =+85°C	
Mean Time To Failures		>100		years	T _{CASE} =+85 °C	
Power Supply					With 22Ω bias resistor	
Device Operating Voltage		3.3		V	At pin 3 with I _{CC} =35mA	
		5.0		V	At evaluation board connector, I _{CC} =35 mA	
Operating Current		35	50	mA	See Note 2.	

Note 1: All specification and characterization data has been gathered on standard FR-4 evaluation boards. These evaluation boards are not optimized for frequencies above 2.5 GHz. Performance above 2.5 GHz may improve if a high performance PCB is used.

Note 2: The RF3376 must be operated below 50 mA. 35 mA to 45 mA is the recommended bias to ensure the highest possible reliability and electrical performance.

Note 3: Because of process variations from part to part, the current resulting from a fixed bias voltage will vary. As a result, caution should be used in designing fixed voltage bias circuits to ensure the worst case bias current does not exceed 50 mA over all intended operating conditions.



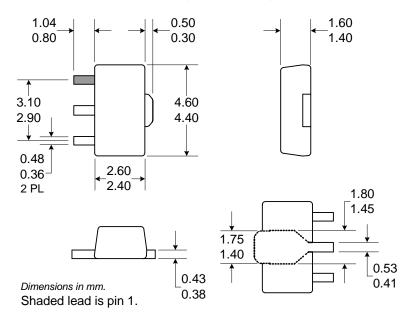
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GND

Ground connection.

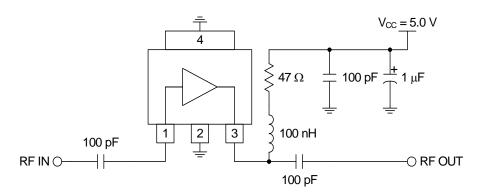
Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. This pin is NOT internally DC blocked. A DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
2	GND	Ground connection.	
3	RF OUT	RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V_{CC} . The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{SUPPLY} - V_{DEVICE})}{I_{CC}}$ Care should also be taken in the resistor selection to ensure that the current into the part never exceeds 40 mA over the planned operating temperature. This means that a resistor between the supply and this pin is always required, even if a supply near 3.4V is available, to provide DC feedback to prevent thermal runaway. Because DC is present on this pin, a DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed.	RF INO TO RF OUT

Package Drawing

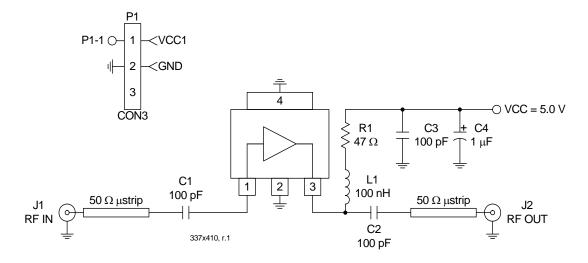




Application Schematic



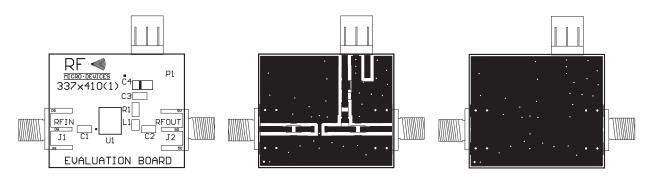
Evaluation Board Schematic





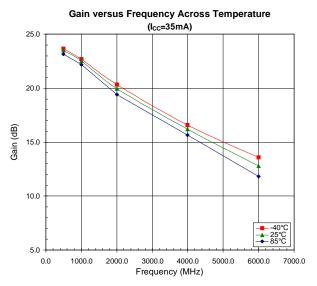
Evaluation Board Layout Board Size 1.195" x 1.000"

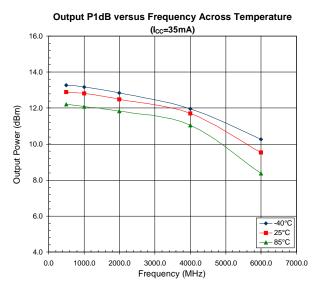
Board Thickness 0.033", Board Material FR-4

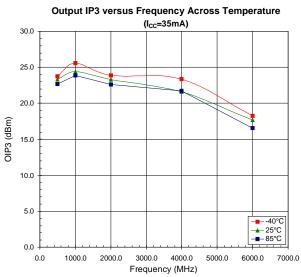


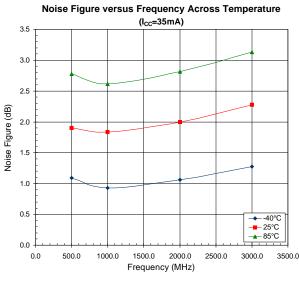
RF3376

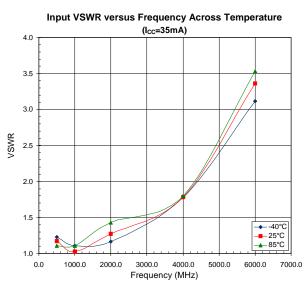


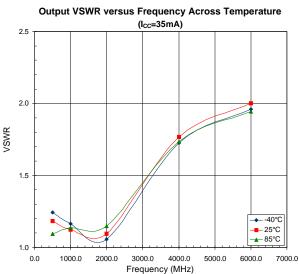






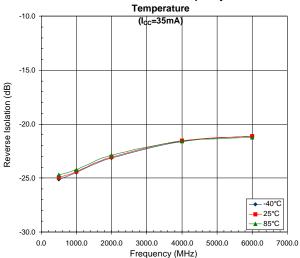




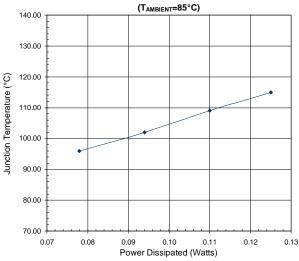




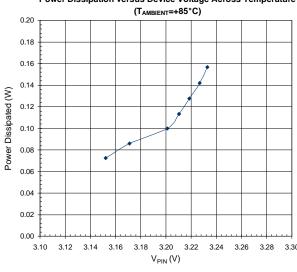




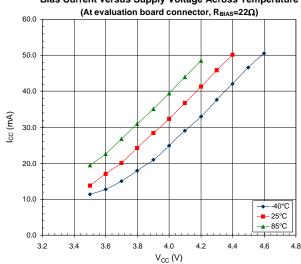
Junction Temperature versus Power Dissipated



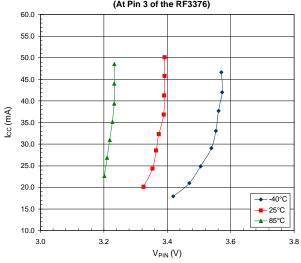
Power Dissipation versus Device Voltage Across Temperature



Bias Current versus Supply Voltage Across Temperature



Bias Current versus Devices Voltage Across Temperature (At Pin 3 of the RF3376)



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